ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and	mposition De 5. IPC, Bannockl Pan-American co	claration ourn, Illinois. A opyright conver	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarati he declaration e	on of the sub ncompasses	ostances v all lower	vithin the manufac level materials for	turer listed which the	item. Note: i manufacture	f the item is an as has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Dist				pe * Declaration Class * e Class 6 - RoHS Yes/No, Homogeneous Mate				erials and l	ials and Mfg Information				
upplier Information														
Company name*			Company unique ID			Unique ID Authority				Respo	Response Date*			
onsemi										2023-0	2023-06-08			
Contact Name Tit			Title - Contact			Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards P			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title			Title - Representative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number			ber Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type	
	NCP137	NCP1377PG ANA PWM		CURRNT MODE CNTRL		2023-06-08		PI	PH1		471.68	mg	Each	
Ianufacturing Proccess Inform	mation					•						•		
Terminal Plating / Grid Array	Terminal Plating / Grid Array Material Terminal Ba		Alloy J-STD-020 MSL R		L Rating	Peak Process Body Temperat		mperature	Max Time at Pe	ak Temper	ature Numb	er of Reflow Cyc	cles	
Matte Tin (Sn) - annealed		CU Alloy NA		NA		0 C		С	30	seco	onds 3			
omments														
or more information regarding mate	rial composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Iercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl te (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.19	mg	Supplier	Silicon (Si)	7440-21-3		2.19	mg
Die Attach	8.92	mg	Supplier	Silver (Ag)	7440-22-4		6.69	mg
			Supplier	Epoxy resins	129915-35-1		2.23	mg
Lead Frame	131.05	mg	Supplier	Silver (Ag)	7440-22-4		0.9173	mg
			Supplier	Zinc (Zn)	7440-66-6		0.2621	mg
			Supplier	Iron (Fe)	7439-89-6		3.4073	mg
			Supplier	Copper (Cu)	7440-50-8		126.4632	mg
Mold Compound-Black	317.53	mg		Epoxy Phenol Resin	proprietary data		33.3406	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		284.1893	mg
Plating	11.9	mg	Supplier	Tin (Sn)	7440-31-5		11.9	mg
Wire Bond	0.09	mg	Supplier	Palladium (Pd)	7440-05-3		0.0009	mg
			Supplier	Copper (Cu)	7440-50-8		0.0891	mg